



EXPEDITED PROCEDURE – EXAMINING GROUP 3729

10/815,464

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| Applicant: | Todd B Myers et al. | Examiner: | Thiem Phan |
| Serial No.: | 10/815,464 | Group Art Unit: | 3729 |
| Filed: | March 31, 2004 | Docket No.: | 884.B60US1 |
| Title: | METHOD OF EMBEDDING PASSIVE COMPONENT WITHIN VIA | | |
| Assignee: | Intel Corporation | Customer Number: | 21186 |

AMENDMENT & RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Final Office Action mailed August 1, 2006, please amend the application as follows: